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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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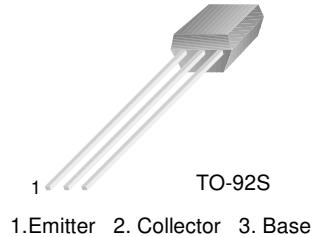
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



FJNS4206R

Switching Application (Bias Resistor Built In)

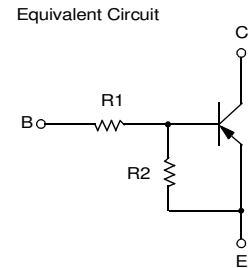
- Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor ($R_1=10K\Omega$, $R_2=47K\Omega$)
- Complement to FJNS3206R



PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	-50	V
V_{CEO}	Collector-Emitter Voltage	-50	V
V_{EBO}	Emitter-Base Voltage	-10	V
I_C	Collector Current	-100	mA
P_C	Collector Power Dissipation	300	mW
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-55 ~ 150	$^\circ\text{C}$



Electrical Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C = -10\mu\text{A}$, $I_E = 0$	-50			V
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = -100\mu\text{A}$, $I_B = 0$	-50			V
I_{CBO}	Collector Cut-off Current	$V_{CB} = -40\text{V}$, $I_E = 0$			-0.1	μA
h_{FE}	DC Current Gain	$V_{CE} = -5\text{V}$, $I_C = -5\text{mA}$	68			
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = -10\text{mA}$, $I_B = -0.5\text{mA}$			-0.3	V
C_{ob}	Output Capacitance	$V_{CB} = -10\text{V}$, $I_E = 0$ $f = 1.0\text{MHz}$		5.5		pF
f_T	Current Gain Bandwidth Product	$V_{CE} = -10\text{V}$, $I_C = -5\text{mA}$		200		MHz
$V_I(\text{off})$	Input Off Voltage	$V_{CE} = -5\text{V}$, $I_C = -100\mu\text{A}$	-0.3			V
$V_I(\text{on})$	Input On Voltage	$V_{CE} = -0.3\text{V}$, $I_C = -1\text{mA}$			-1.4	V
R_1	Input Resistor		7	10	13	$K\Omega$
R_1/R_2	Resistor Ratio		0.19	0.21	0.24	

Typical Characteristics

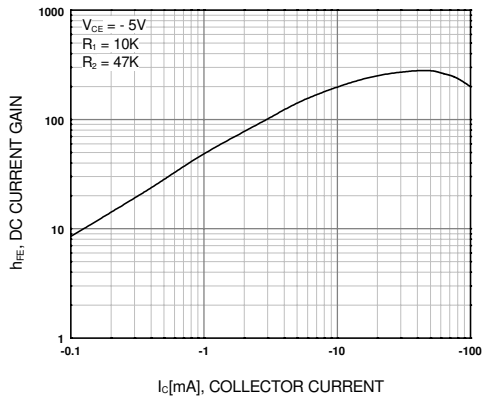


Figure 1. DC current Gain

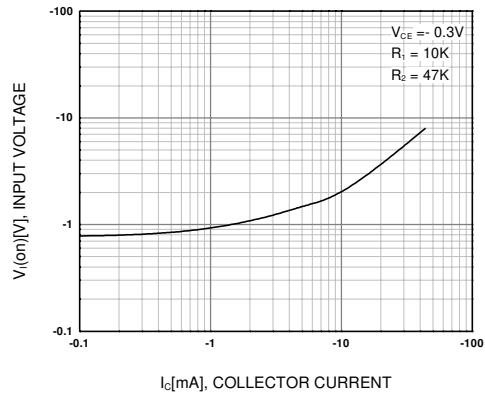


Figure 2. Input On Voltage

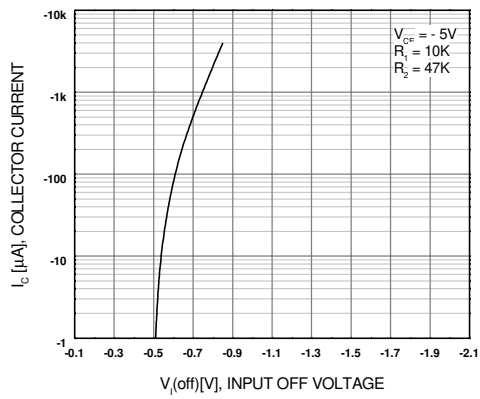


Figure 3. Input Off Voltage

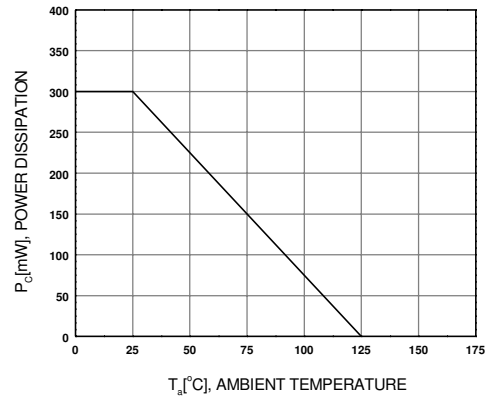
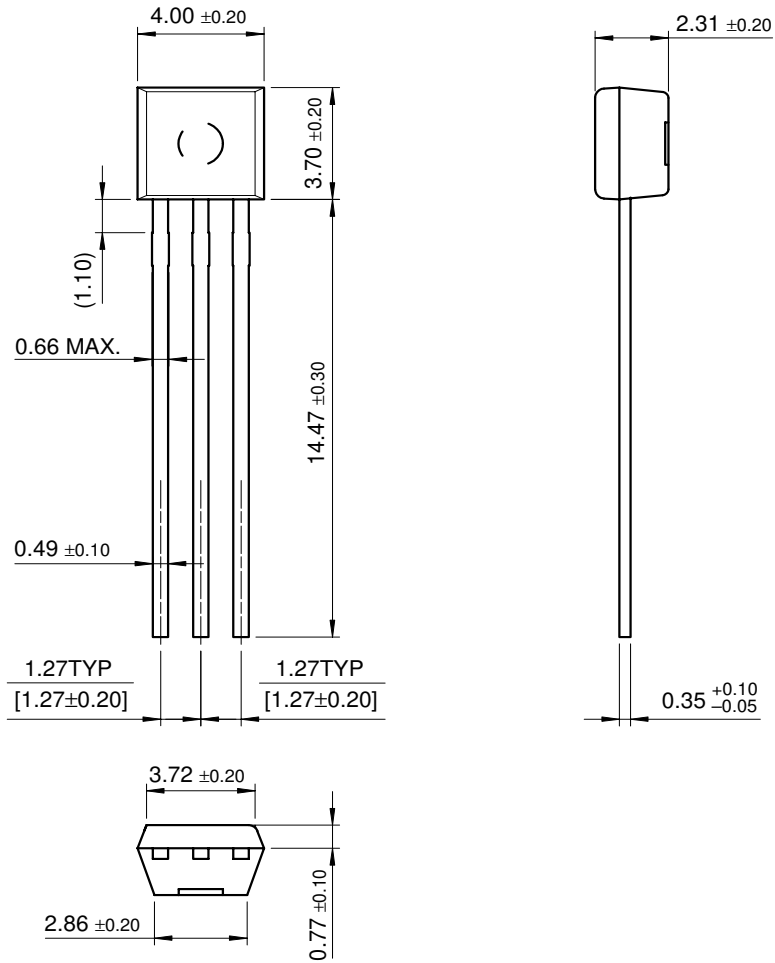


Figure 4. Power Derating

Package Dimensions

TO-92S



Dimensions in Millimeters

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